



TMG12N12LD

N-Channel Enhancement Mosfet

General Description

- Low $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

Applications

- Load switch
- PWM

General Features

$V_{DS} = 120V$ $I_D = 12A$

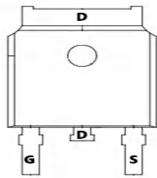
$R_{DS(ON)} = 88m\Omega$ (typ.)@ $V_{GS} = 10V$

100% UIS Tested

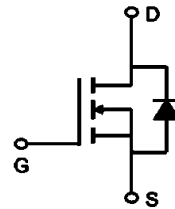
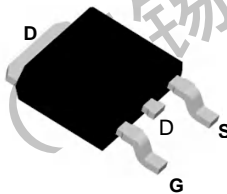
100% R_g Tested



D:TO-252-3L



Marking G12N12L



Absolute Maximum Ratings ($T_C = 25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	120	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	12	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	6.5	A
I_{DM}	Pulsed Drain Current	90	A
EAS	Single Pulse Avalanche Energy	100	mJ
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	29	W
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 175	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	50	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case	---	4.2	$^\circ C/W$



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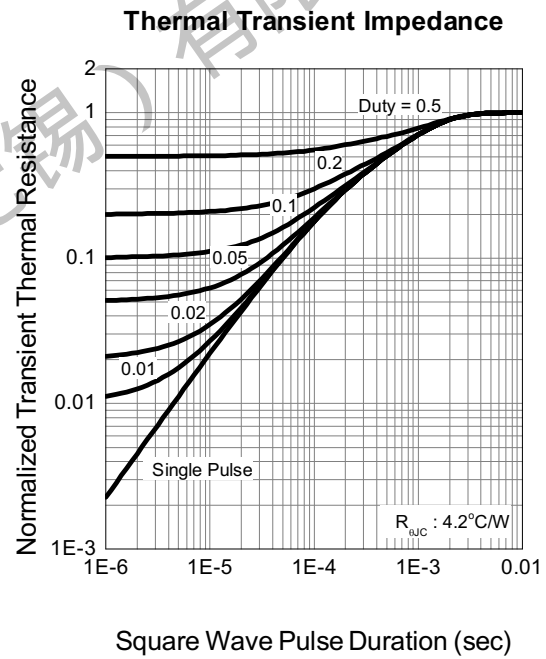
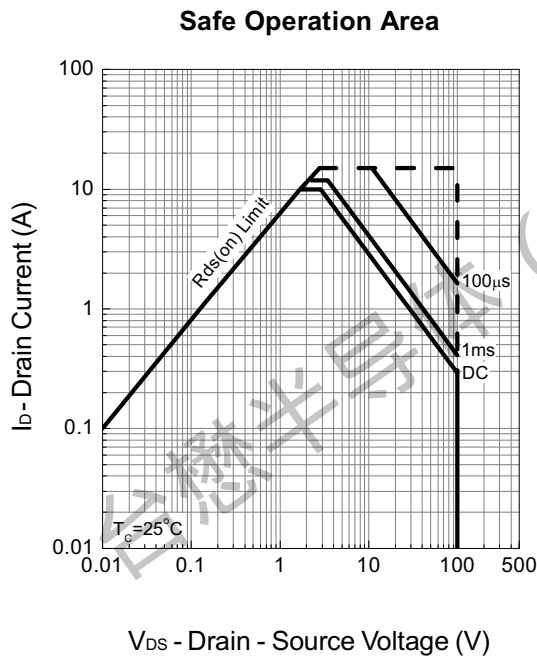
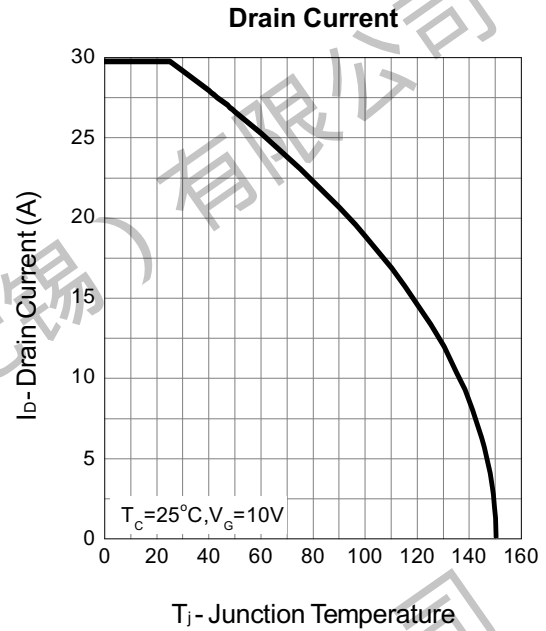
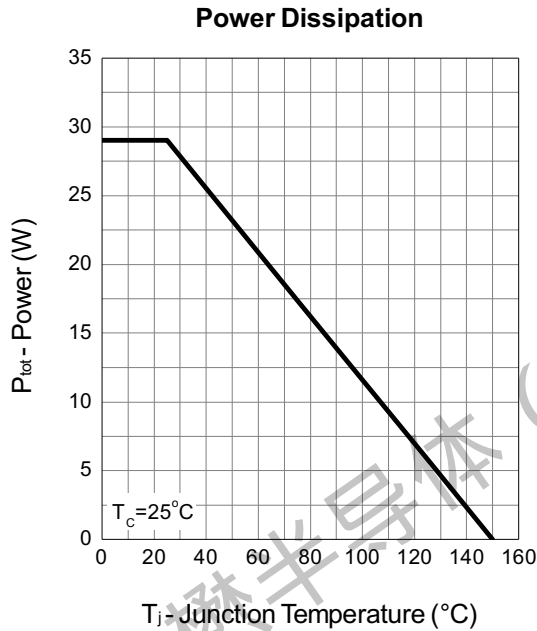
N-Channel Enhancement Mosfet

Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise specified) :

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	120	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=96V, V_{GS}=0V$	-	-	1	μA
		$T_J=85^{\circ}\text{C}$	-	-	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1.0	1.5	2.0	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
$R_{DS(ON)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=5A$	-	88	100	$m\Omega$
		$V_{GS}=4.5V, I_{DS}=4A$	-	110	130	$m\Omega$
Diode Characteristics						
V_{SD}^d	Diode Forward Voltage	$I_{SD}=5A, V_{GS}=0V$	-	0.8	1.3	V
t_{rr}	Reverse Recovery Time	$I_{SD}=5A, dI_{SD}/dt=100A/\mu s$	-	26	-	ns
Q_{rr}	Reverse Recovery Charge		-	36	-	nC
Dynamic Characteristics^e						
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, f=1\text{MHz}$	-	2.5	-	Ω
C_{iss}	Input Capacitance	$V_{GS}=0V, V_{DS}=30V, \text{Frequency}=1.0\text{MHz}$	-	440	570	pF
C_{oss}	Output Capacitance		-	30	-	
C_{riss}	Reverse Transfer Capacitance		-	16	-	ns
$t_{d(ON)}$	Turn-on Delay Time		-	9	17	
t_r	Turn-on Rise Time	$V_{DD}=30V, R_L=30\Omega, I_{DS}=1A, V_{GEN}=10V, R_G=6\Omega$	-	7	13	
$t_{d(OFF)}$	Turn-off Delay Time		-	18	33	
t_f	Turn-off Fall Time		-	4	8	
Gate Charge Characteristics^e						
Q_g	Total Gate Charge	$V_{DS}=30V, V_{GS}=4.5V, I_{DS}=5A$	-	4.5	-	nC
Q_g	Total Gate Charge	$V_{DS}=30V, V_{GS}=10V, I_{DS}=5A$	-	10	14	
Q_{gs}	Gate-Source Charge		-	2	-	
Q_{gd}	Gate-Drain Charge		-	1.8	-	



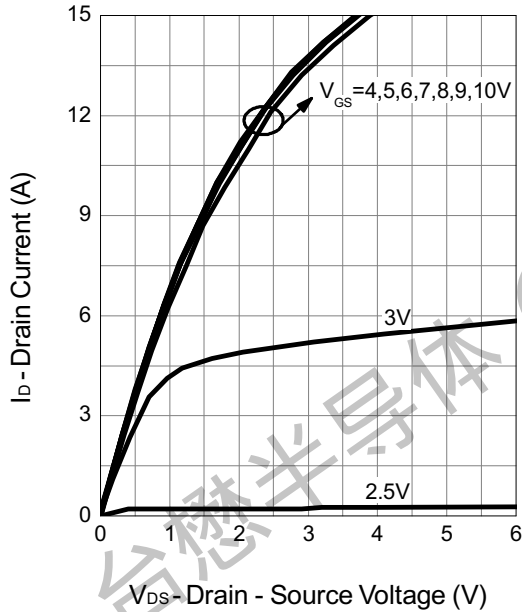
Typical Operating Characteristics



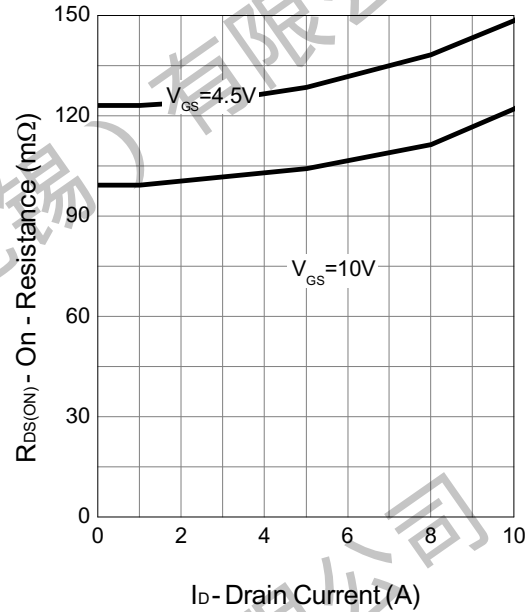


Typical Operating Characteristics (Cont.)

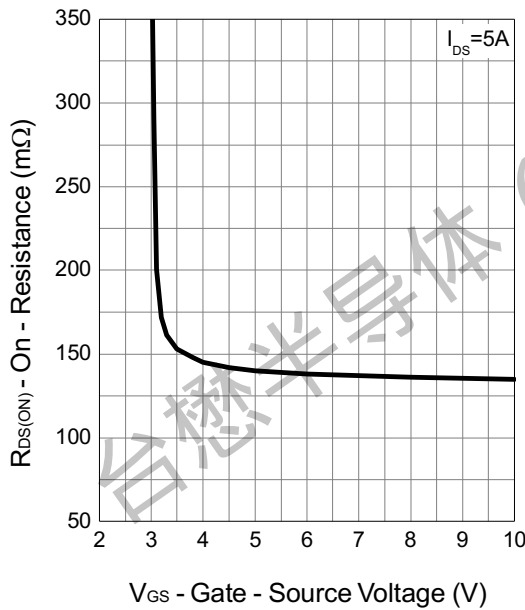
Output Characteristics



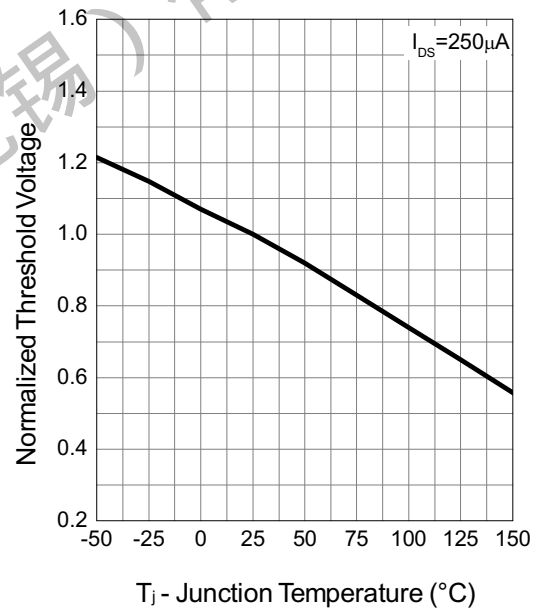
Drain-Source On Resistance



Gate-Source On Resistance

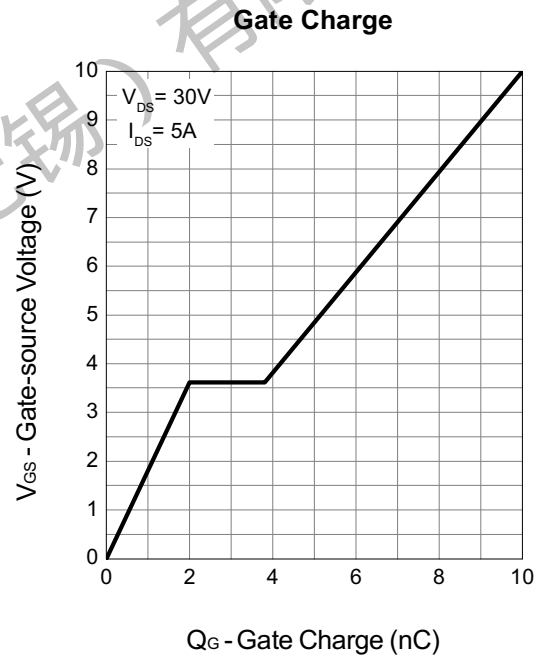
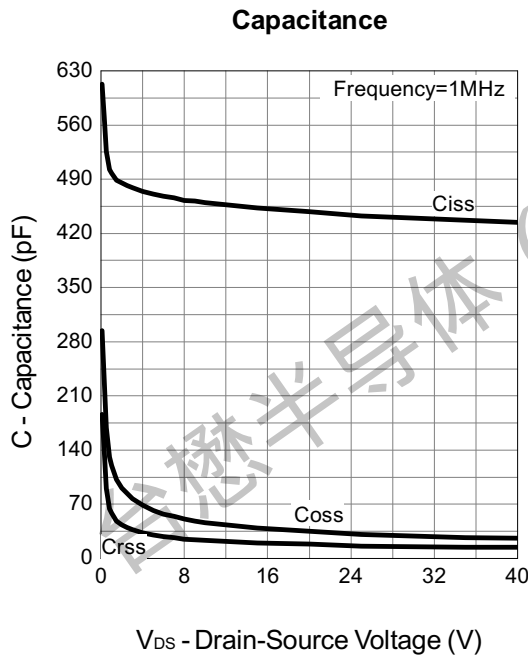
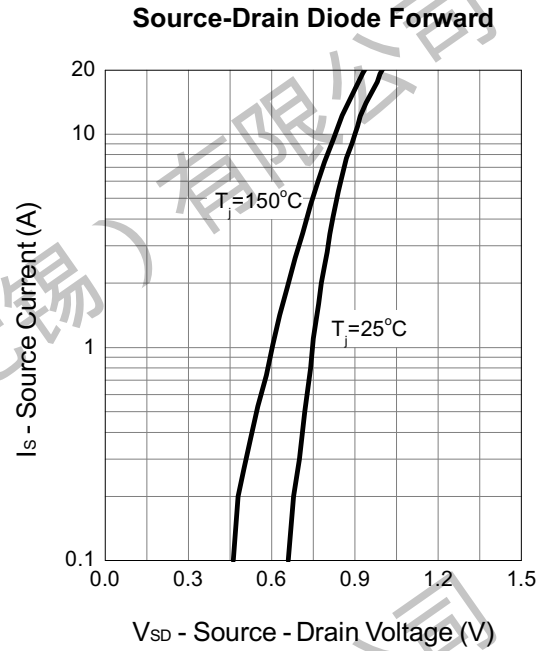
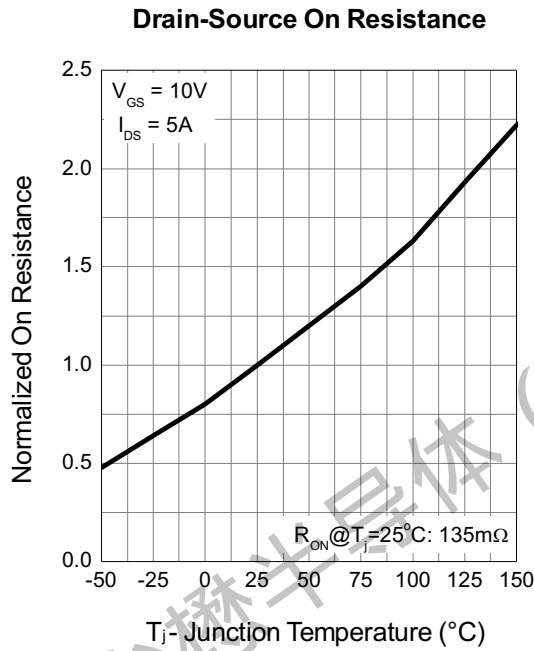


Gate Threshold Voltage





Typical Operating Characteristics (Cont.)

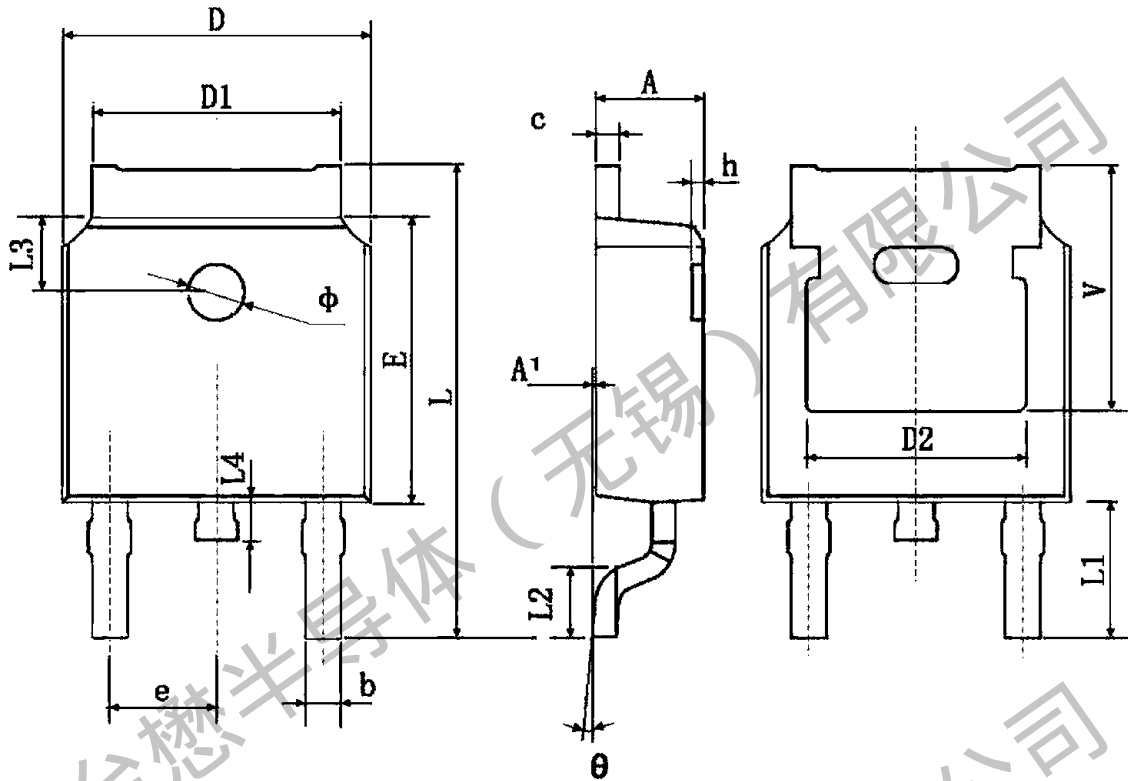




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Package Mechanical Data: TO-252-3L



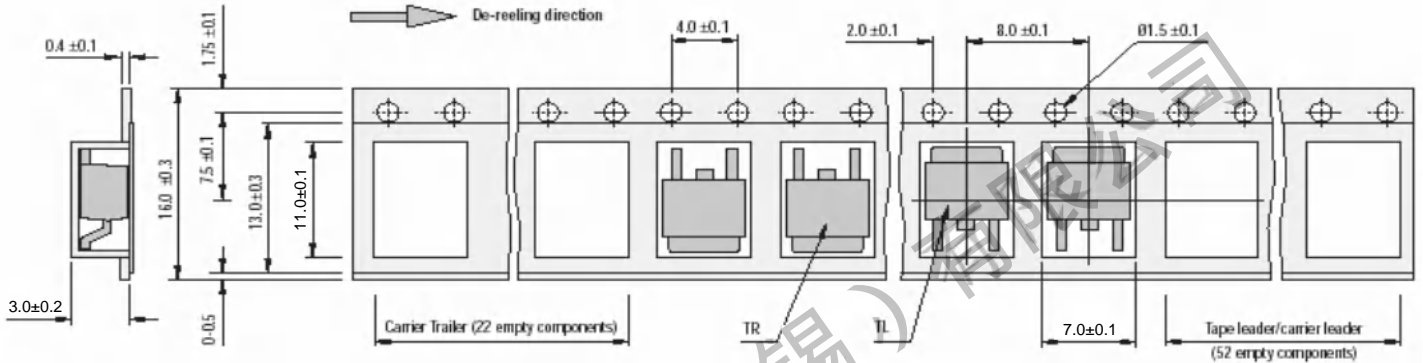
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	



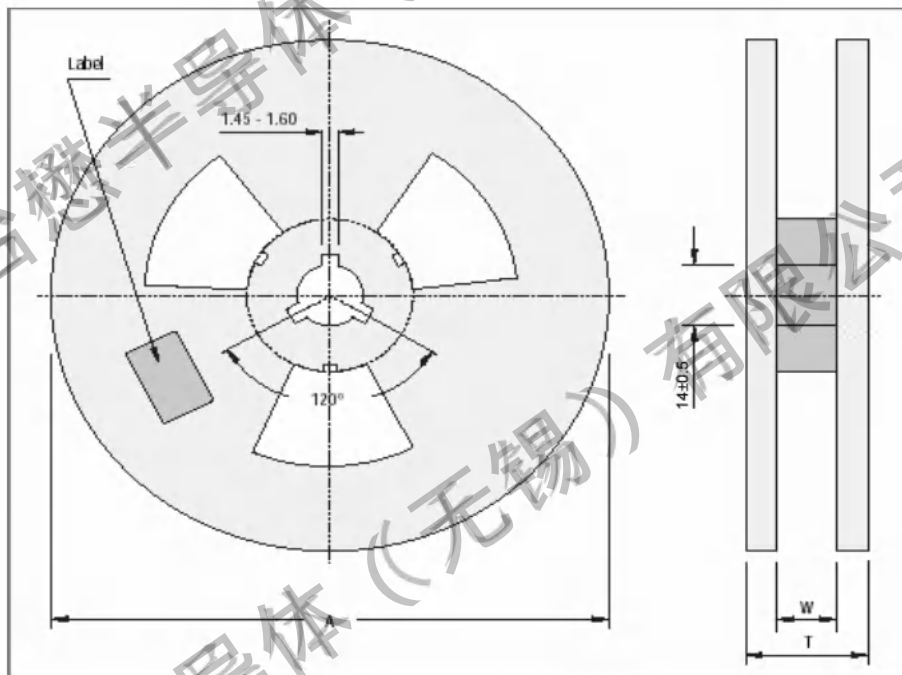
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TO-252-3L Embossed Carrier Tape



TO-252-3L Reel



All Dimensions are in mm.

Reel Specifications				
Package	Tape Width	Reel Dia. A - Max	Inside Thickness W	Reel Thickness T - max
TO-252-3L	16	330	18.0 ±1.5	20

Packaging Information

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
2,500 pcs	13 inch	5,000 pcs	355×370×50	25,000 pcs	380×275×380	



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Revision history:

Date	Rev	Description	Page
2024.12.23	24.12	Original	